

TD827 Series

#### Description

The TD827 series provide two channel operation, and each combines an AlGaAs infrared emitting diode as the emitter which is optically coupled to a silicon planar phototransistor detector in a plastic DIP8 package with different lead forming options.

With the robust coplanar double mold structure, TD810 series provide the most stable isolation feature.

#### Features

- High isolation 5000 VRMS
- DC input with transistor output
- Operating temperature range 55 °C to 110 °C
- REACH compliance
- Halogen free (Optional)
- MSL class 1
- Regulatory Approvals
  - UL UL1577
  - VDE EN60747-5-5(VDE0884-5)
  - CQC GB4943.1, GB8898

#### Applications

- Computer peripheral interface
- Microprocessor system interface

# SCHEMATIC 2 3 **PIN DEFINITION** 1. Anode 8. Collector 2. Cathode 7. Emitter 3. Anode 6. Collector 4. Cathode 5. Emitter PAKCAGE OUTLINE



ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	VALUE	UNIT	NOTE			
INPUT							
Forward Current	IF	60	mA				
Peak Forward Current	I <sub>FP</sub>	1	A	1			
Reverse Voltage	VR	6	V				
Input Power Dissipation	Pi	100	mW				
OUTPUT							
Collector - Emitter Voltage	V <sub>CEO</sub>	80	V				
Emitter - Collector Voltage	V <sub>ECO</sub>	6	V				
Collector Current	lc	50	mA				
Output Power Dissipation	Po	150	mW				
COMMON							
Total Power Dissipation	Ptot	200	mW				
Isolation Voltage	Viso	5000	Vrms	2			
Operating Temperature	Topr	-55~110	°C				
Storage Temperature	Tstg	-55~125	°C				
Soldering Temperature	Tsol	260	°C				

Note 1. 100µs pulse, 100Hz frequency Note 2. AC For 1 Minute, R.H. = 40 ~ 60%

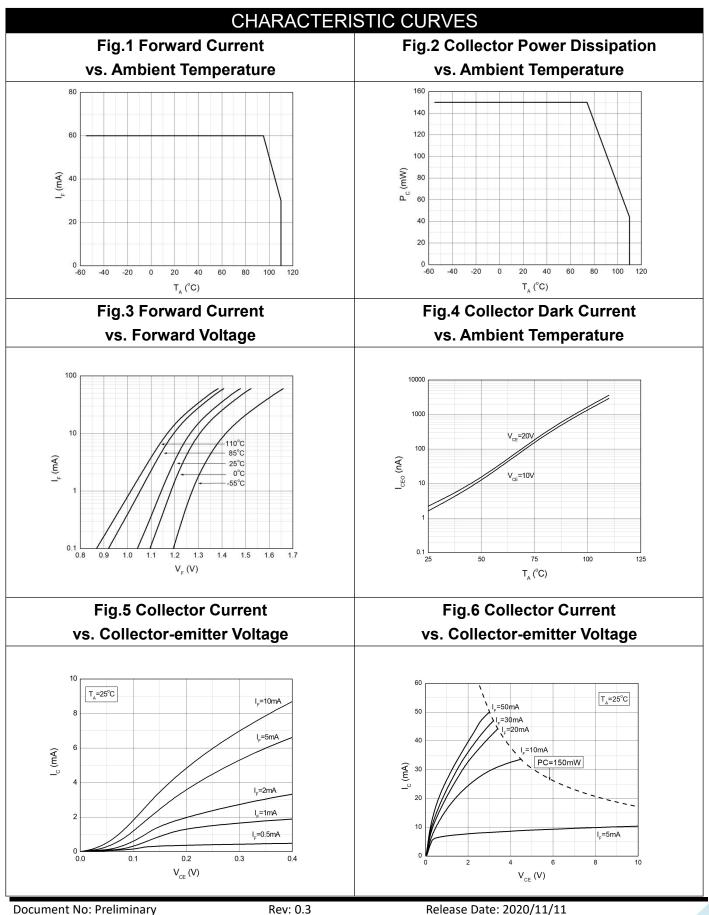


	ELECT	RICAL OI	PTICA	L CHA	RAC	TER	ISTICS at Ta=25°C		
PARAMET	TER	SYMBOL	MIN	TYP.	MAX.	UNIT	TEST CONDITION	NOTE	
INPUT									
Forward Vo	oltage	VF	-	1.24	1.4	V	IF=10mA		
Reverse Cu	urrent	I <sub>R</sub>	-	-	10	μA	VR=6V		
Input Capac	itance	Cin	-	10	-	pF	V=0, f=1kHz		
OUTPUT									
Collector Dark	Current	I <sub>CEO</sub>	-	-	100	nA	VCE=20V, IF=0		
Collector-E	llector-Emitter		xF0 80			v			
Breakdown V	/oltage	BV <sub>CEO</sub>	00	-	-	V	IC=0.1mA, IF=0		
Emitter-Coll	lector	BV <sub>ECO</sub>	6		V	IE=0.1mA, IF=0			
Breakdown V	/oltage	DVECO	0	-	-	V	IE-0. IIIA, IF-0		
	TRANSFER CHARACTERISTICS								
Current									
Transfer	TD827	CTR	130	-	400	%	IF=5mA, VCE=5V		
Ratio									
Collector-Emitter		V <sub>CE(sat)</sub>	-	0.06	0.2	V	IF=20mA, IC=1mA		
Saturation V	Saturation Voltage								
Isolation Res	istance	R <sub>ISO</sub>	10^12	10^14	-	Ω	DC500V, 40 ~ 60% R.H.		
Floating Capa	acitance	Cio	-	0.4	1	pF	V=0, f=1MHz		
Cut-off Frequency		fc -		80	-	kHz	VCE=2V, IC=2mA	3	
			-	00			RL=100Ω,-3dB	5	
Response Tim	ne (Rise)	tr	-	6	18	μs	VCE=2V, IC=2mA	4	
Response Tim	ne (Fall)	tf	-	8	18	μs	RL=100Ω	4	

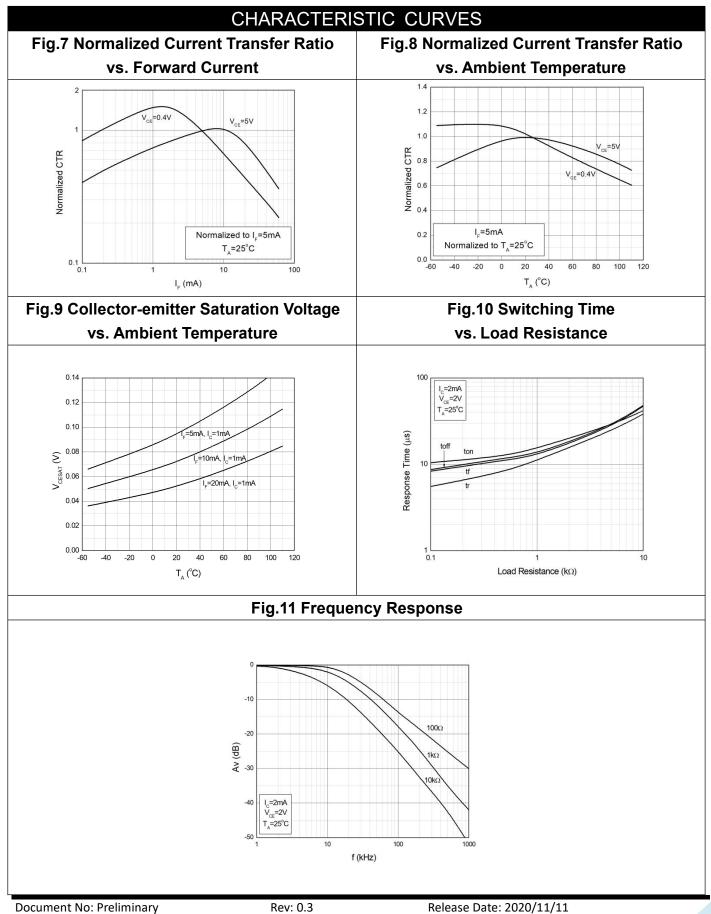
Note 3. Fig.14

Note 4. Fig.12&13



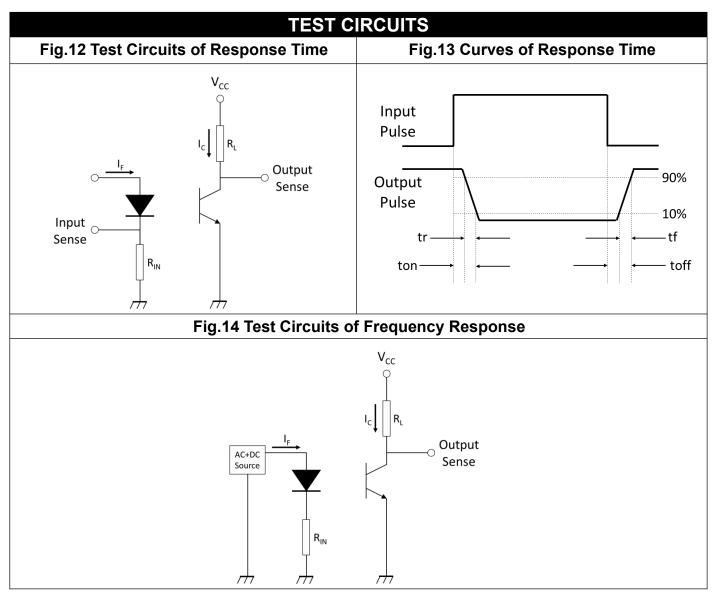




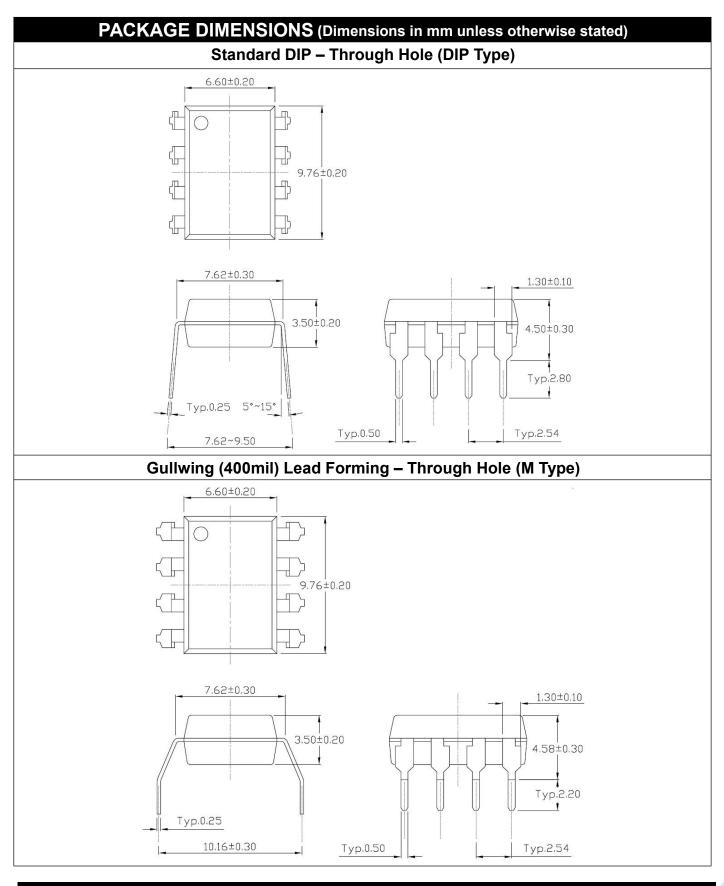




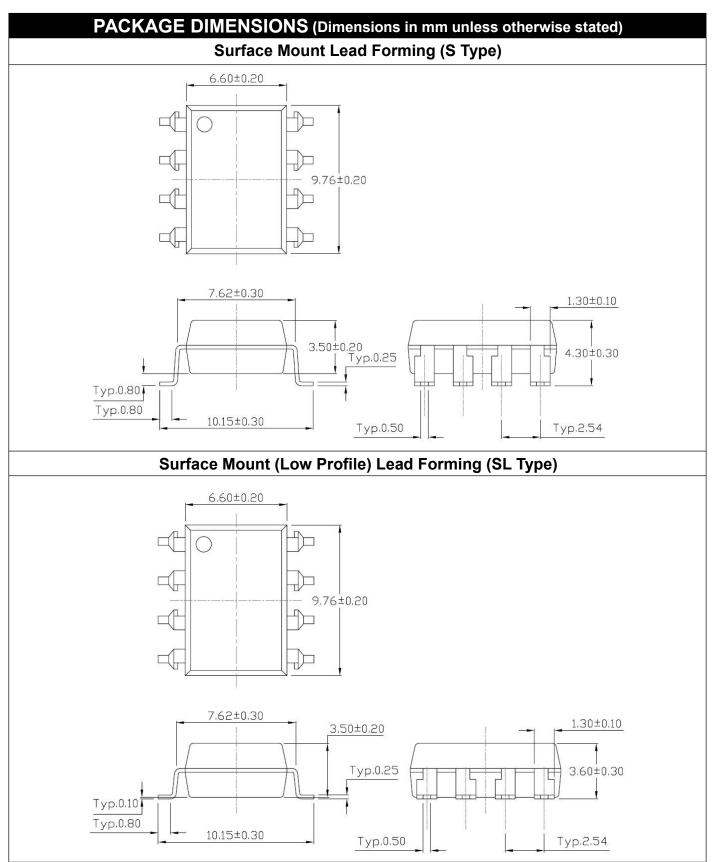
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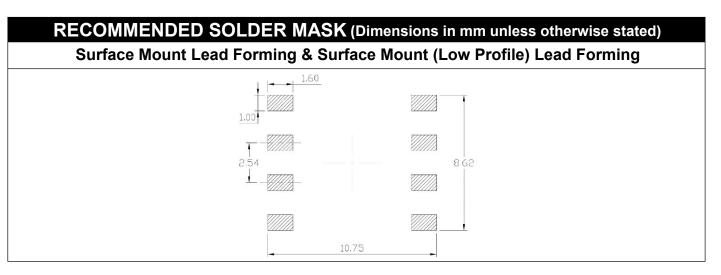




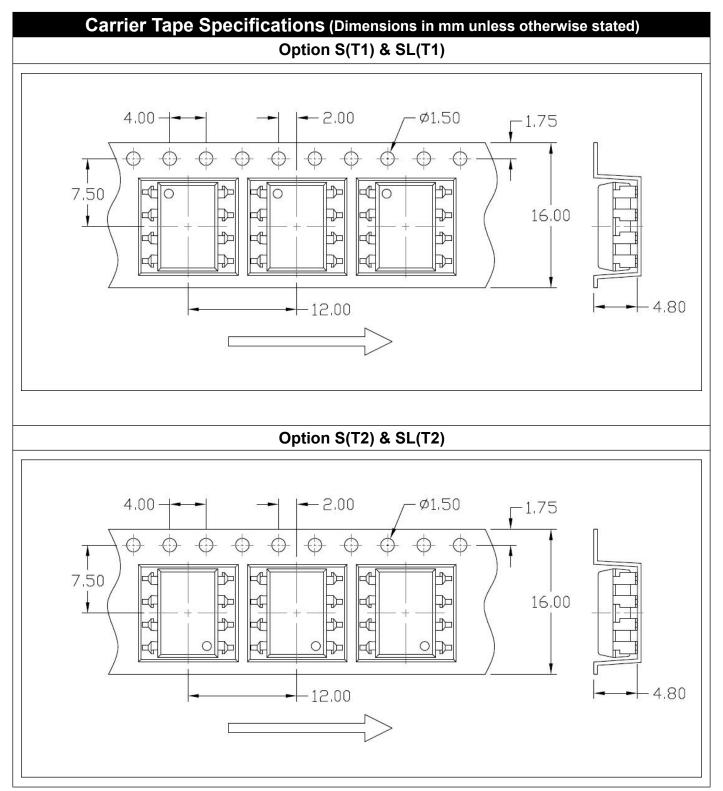




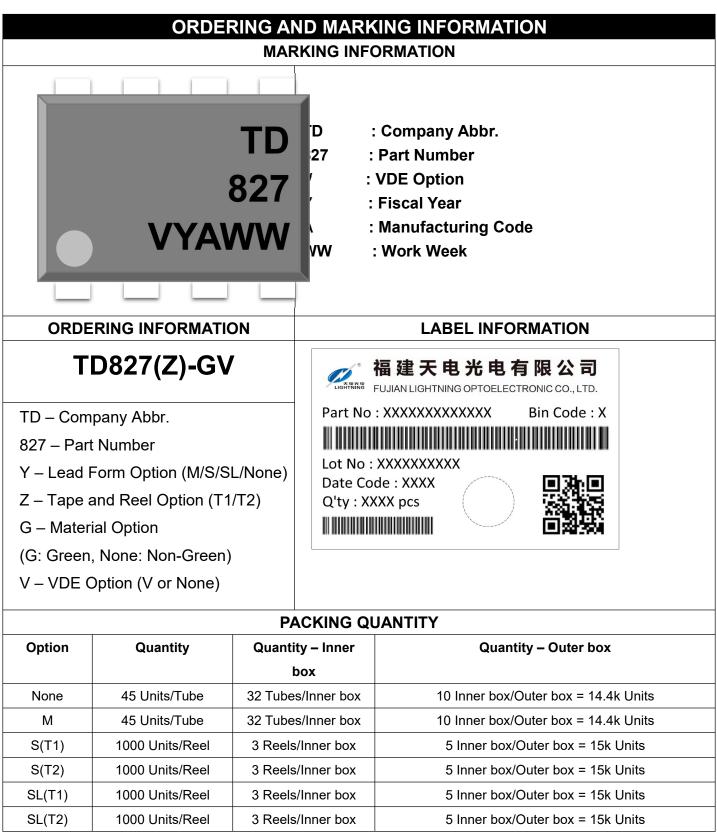








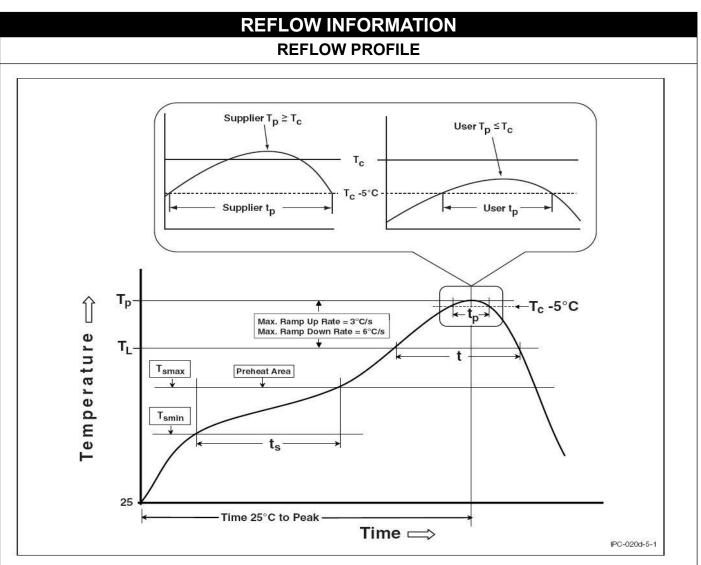






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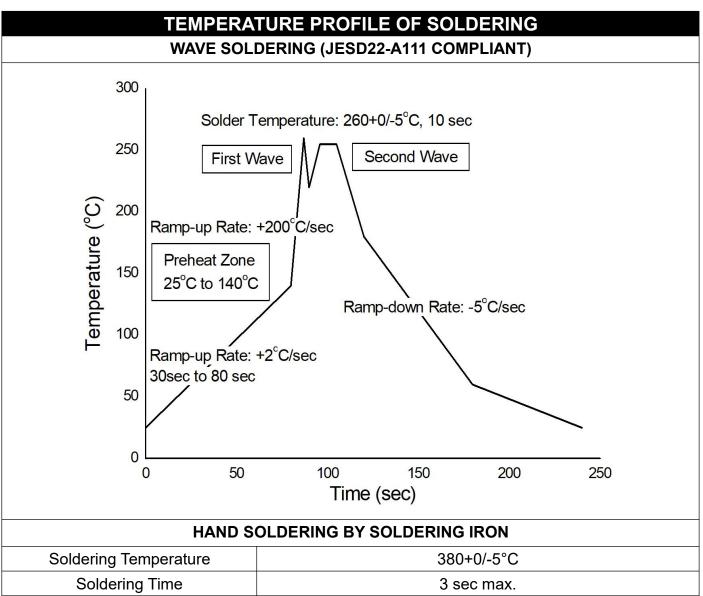
DIP8, DC Input, Phototransistor Photo Coupler



Profile Feature	Sn-Pb Assembly Profile	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	100	150°C
Temperature Max. (Tsmax)	150	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds	60-120 seconds
Ramp-up Rate (tL to tP)	3°C/second max.	3°C/second max.
Liquidous Temperature (TL)	183°C	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds	60 – 150 seconds
Peak Body Package Temperature	235°C +0°C / -5°C	260°C +0°C / -5°C
Time (tP) within 5°C of 260°C	20 seconds	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max	6°C/second max
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Document No: Preliminary





- One time soldering is recommended for all soldering method.
- Do not solder more than three times for IR reflow soldering.



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